



January 1988  
Revised August 2000

## MM74HC597

### 8-Bit Shift Registers with Input Latches

#### General Description

This high speed register utilizes advanced silicon-gate CMOS technology. It has the high noise immunity and low power consumption of standard CMOS integrated circuits, as well as the ability to drive 10 LS-TTL loads.

The MM74HC597 comes in a 16-pin package and consists of an 8-bit storage latch feeding a parallel-in, serial-out 8-bit shift register. Both the storage register and shift register have positive-edge triggered clocks. The shift register also has direct load (from storage) and clear inputs.

The 74HC logic family is speed, function, and pin-out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to  $V_{CC}$  and ground.

#### Features

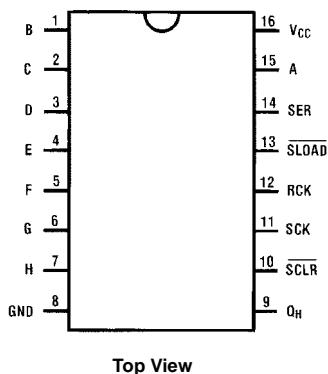
- 8-bit parallel storage register inputs
- Wide operating voltage range: 2V–6V
- Shift register has direct overriding load and clear
- Guaranteed shift frequency: DC to 30 MHz
- Low quiescent current: 80  $\mu$ A maximum

#### Ordering Code:

Order Number	Package Number	Package Description
MM74HC597M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
MM74HC597SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HC597N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

#### Connection Diagram

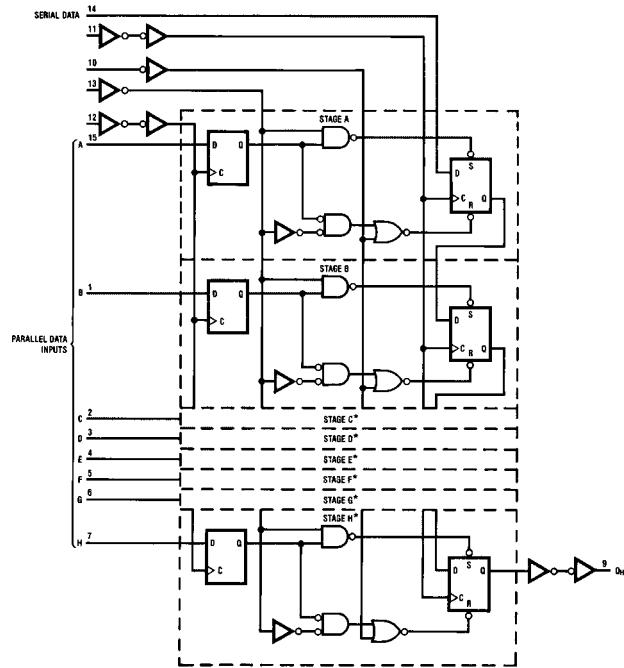


#### Truth Table

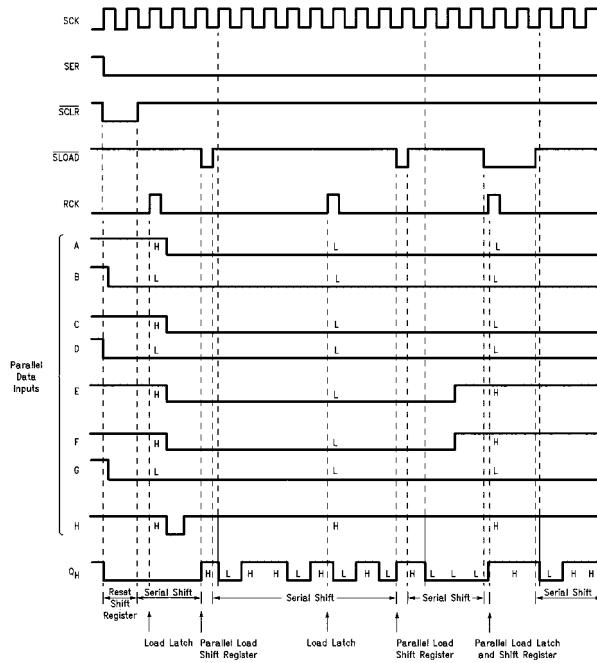
RCK	SCK	SLOAD	SCLR	Function
↑	X	X	X	Data Loaded to input latches
↑	X	L	H	Data loaded from inputs to shift register
No clock edge	X	L	H	Data transferred from input latches to shift register
X	X	L	L	Invalid logic, state of shift register indeterminate when signals removed
X	X	H	L	Shift register cleared
X	↑	H	H	Shift register clocked $Q_n = Q_{n-1}$ , $Q_0 = \text{SER}$

MM74HC597

### Functional Block Diagram (Positive Logic)



### Timing Diagram



Absolute Maximum Ratings (Note 1)				Recommended Operating Conditions				
(Note 2)					Min	Max	Units	
Supply Voltage ( $V_{CC}$ )	-0.5 to +7.0V			Supply Voltage ( $V_{CC}$ )	2	6	V	
DC Input Voltage ( $V_{IN}$ )	-1.5 to $V_{CC}+1.5V$			DC Input or Output Voltage ( $V_{IN}, V_{OUT}$ )	0	$V_{CC}$	V	
DC Output Voltage ( $V_{OUT}$ )	-0.5 to $V_{CC}+0.5V$			Operating Temperature Range ( $T_A$ )	-40	+85	°C	
Clamp Diode Current ( $I_{IK}, I_{OK}$ )	$\pm 20$ mA			Input Rise or Fall Times ( $t_r, t_f$ )	$V_{CC} = 2.0V$	1000	ns	
DC Output Current, per pin ( $I_{OUT}$ )	$\pm 25$ mA			$V_{CC} = 4.5V$		500	ns	
DC $V_{CC}$ or GND Current, per pin ( $I_{CC}$ )	$\pm 70$ mA			$V_{CC} = 6.0V$		400	ns	
Storage Temperature Range ( $T_{STG}$ )	-65°C to +150°C							
Power Dissipation ( $P_D$ )								
(Note 3)	600 mW							
S.O. Package only	500 mW							
Lead Temperature ( $T_L$ ) (Soldering 10 seconds)	260°C							
DC Electrical Characteristics (Note 4)				Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur. Note 2: Unless otherwise specified all voltages are referenced to ground. Note 3: Power Dissipation temperature derating — plastic "N" package: -12 mW/°C from 65°C to 85°C.				
Symbol	Parameter	Conditions	$V_{CC}$	$T_A = 25^\circ C$		$T_A = -40$ to $85^\circ C$	$T_A = -55$ to $125^\circ C$	Units
				Typ		Guaranteed Limits		
$V_{IH}$	Minimum HIGH Level Input Voltage		2.0V		1.5	1.5	1.5	V
			4.5V		3.15	3.15	3.15	
			6.0V		4.2	4.2	4.2	
$V_{IL}$	Maximum LOW Level Input Voltage (Note 5)		2.0V		0.5	0.5	0.5	V
			4.5V		1.35	1.35	1.35	
			6.0V		1.8	1.8	1.8	
$V_{OH}$	Minimum HIGH Level Output Voltage	$V_{IN} = V_{IH}$ or $V_{IL}$	2.0V	2.0	1.9	1.9	1.9	V
			4.5V	4.5	4.4	4.4	4.4	
			6.0V	6.0	5.9	5.9	5.9	
		$V_{IN} = V_{IH}$ or $V_{IL}$	4.5V	4.2	3.98	3.84	3.7	V
		$ I_{OUT}  \leq 4.0$ mA	6.0V	5.2	5.48	5.34	5.2	
		$ I_{OUT}  \leq 5.2$ mA						
$V_{OL}$	Maximum LOW Level Output Voltage	$V_{IN} = V_{IH}$ or $V_{IL}$	2.0V	0	0.1	0.1	0.1	V
			4.5V	0	0.1	0.1	0.1	
			6.0V	0	0.1	0.1	0.1	
		$V_{IN} = V_{IH}$ or $V_{IL}$	4.5V	0.2	0.26	0.33	0.4	V
		$ I_{OUT}  \leq 4$ mA	6.0V	0.2	0.26	0.33	0.4	
	$ I_{OUT}  \leq 5.2$ mA							
$I_{IN}$	Maximum Input Current	$V_{IN} = V_{CC}$ or GND	6.0V		$\pm 0.1$	$\pm 1.0$	$\pm 1.0$	$\mu A$
$I_{CC}$	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	6.0V		8.0	80	160	$\mu A$
		$I_{OUT} = 0$ $\mu A$						
Note 4: For a power supply of $5V \pm 10\%$ the worst case output voltages ( $V_{OH}$ and $V_{OL}$ ) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case $V_{IH}$ and $V_{IL}$ occur at $V_{CC} = 5.5V$ and 4.5V respectively. (The $V_{IH}$ value at 5.5V is 3.85V.) The worst case leakage current ( $I_{IN}$ , $I_{CC}$ , and $I_{OZ}$ ) occur for CMOS at the higher voltage and so the 6.0V values should be used.								
Note 5: $V_{IL}$ limits are currently tested at 20% of $V_{CC}$ . The above $V_{IL}$ specification (30% of $V_{CC}$ ) will be implemented no later than Q1, CY'89.								

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**MM74HC597**

**AC Electrical Characteristics**  $V_{CC} = 5V$ ,  $T_A = 25^\circ C$ ,  $C_L = 15 \text{ pF}$ ,  $t_r = t_f = 6 \text{ ns}$

Symbol	Parameter	Conditions	Typ	Guaranteed Limit	Units
$f_{MAX}$	Maximum Operating Frequency of SCK		50	30	MHz
$t_{PHL}$ $t_{PLH}$	Maximum Propagation Delay from SCK to $Q_H$		20	30	ns
$t_{PHL}$ $t_{PLH}$	Maximum Propagation Delay from $\overline{SLOAD}$ to $Q_H$		20	30	ns
$t_{PHL}$ $t_{PLH}$	Maximum propagation Delay from RCK to $Q_H$	$\overline{SLOAD} = \text{logic "0"}$	25	45	ns
$t_{PHL}$	Maximum Propagation Delay from $\overline{SCLR}$ to $Q_H$		20	30	ns
$t_{REM}$	Minimum Removal Time, $\overline{SCLR}$ to SCK		10	20	ns
$t_s$	Minimum Setup Time from RCK to SCK		30	40	ns
$t_s$	Minimum Setup Time from SER to SCK		10	20	ns
$t_s$	Minimum Setup Time from inputs A thru H to RCK		10	20	ns
$t_H$	Minimum Hold Time		-2	0	ns
$t_W$	Minimum Pulse Width SCK, RCK, $\overline{SCLR}$ $\overline{SLOAD}$		10	16	ns

**AC Electrical Characteristics**  $V_{CC} = 2.0\text{--}6.0V$ ,  $C_L = 50 \text{ pF}$ ,  $t_r = t_f = 6 \text{ ns}$  (unless otherwise specified)

Symbol	Parameter	Conditions	$V_{CC}$	$T_A = 25^\circ C$		$T_A = -40 \text{ to } 85^\circ C$	$T_A = -55 \text{ to } 125^\circ C$	Units
				Typ	Guaranteed Limits			
$f_{MAX}$	Maximum Operating Frequency		2.0V 4.5V 6.0V	10 45 50	6.0 30 35	4.8 24 28	4.0 20 24	MHz
$t_{PHL}$ $t_{PLH}$	Maximum Propagation Delay from SCK to $Q_H$		2.0V 4.5V 6.0V	62 20 18	175 35 30	220 44 38	263 53 45	ns
$t_{PHL}$ $t_{PLH}$	Maximum Propagation Delay from $\overline{SLOAD}$ to $Q_H$		2.0V 4.5V 6.0V	65 20 18	175 35 30	220 44 38	263 53 45	ns
$t_{PHL}$ $t_{PLH}$	Maximum Propagation Delay from RCK to $Q_H$	$\overline{SLOAD} = \text{Logic "0"}$	2.0V 4.5V 6.0V	120 30 28	205 41 35	255 51 43	310 62 53	ns
$t_{PHL}$	Maximum Propagation Delay from $\overline{SCLR}$ to $Q_H$		2.0V 4.5V 6.0V	66 20 18	175 35 30	220 44 38	263 53 45	ns
$t_{REM}$	Minimum Removal Time $\overline{SCLR}$ to SCK		2.0V 4.5V 6.0V		100 20 17	125 25 21	150 30 25	ns
$t_s$	Minimum Setup Time from RCK to SCK		2.0V 4.5V 6.0V		200 40 34	250 50 42	300 60 50	ns
$t_s$	Minimum Setup Time from SER to SCK		2.0V 4.5V 6.0V		100 20 17	125 25 21	150 30 25	ns

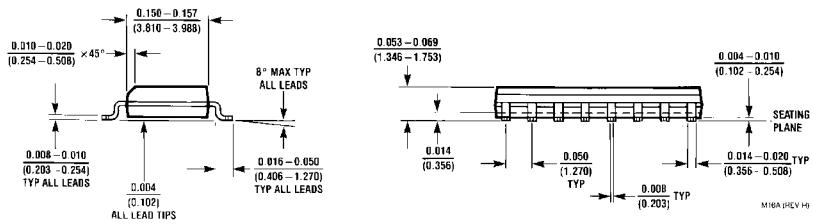
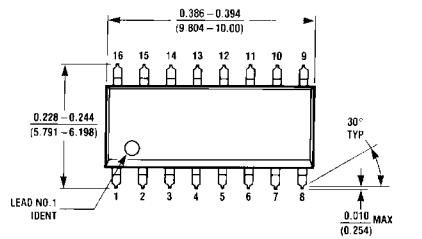
**AC Electrical Characteristics (Continued)**

Symbol	Parameter	Conditions	V <sub>CC</sub>	T <sub>A</sub> = 25°C		T <sub>A</sub> = -40 to 85°C	T <sub>A</sub> = -55 to 125°C	Units
				Typ	Guaranteed Limits			
t <sub>S</sub>	Minimum Setup Time from Inputs A thru H to RCK		2.0V 4.5V 6.0V		100 20 17	125 25 21	150 30 25	ns
t <sub>H</sub>	Minimum Hold Time		2.0V 4.5V 6.0V		0 0 0	0 0 0	0 0 0	ns
t <sub>W</sub>	Minimum Pulse Width SCK, RCK, SCLR, SLOAD		2.0V 4.5V 6.0V	30 9 8	80 16 14	100 20 18	120 24 20	ns
t <sub>r</sub> , t <sub>f</sub>	Maximum Input Rise and Fall Time		2.0V 4.5V 6.0V		1000 500 400	1000 500 400	1000 500 400	ns
t <sub>THL</sub> , t <sub>TLH</sub>	Maximum Output Rise and Fall Time		2.0V 4.5V 6.0V	30 10 8	75 15 13	95 19 16	110 22 19	ns
t <sub>THL</sub> , t <sub>TLH</sub>	Maximum Output Rise and Fall Time		2.0V 4.5V 6.0V		75 15 13	95 19 16	110 22 19	ns
C <sub>PD</sub>	Power Dissipation Capacitance, Outputs (Note 6)			87				pF
C <sub>IN</sub>	Maximum Input Capacitance			5	10	10	10	pF
C <sub>OUT</sub>	Maximum Output Capacitance			15	20	20	20	pF

**Note 6:** C<sub>PD</sub> determines the no load dynamic power consumption, P<sub>D</sub> = C<sub>PD</sub> V<sub>CC</sub><sup>2</sup> f + I<sub>CC</sub> V<sub>CC</sub>, and the no load dynamic current consumption, I<sub>S</sub> = C<sub>PD</sub> V<sub>CC</sub> f + I<sub>CC</sub>.

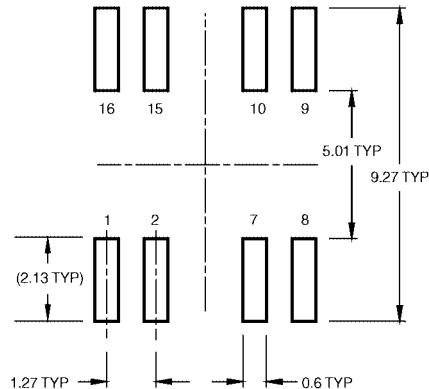
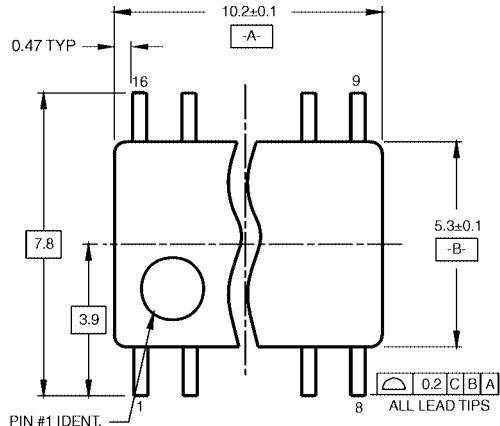
**MM74HC597**

**Physical Dimensions** inches (millimeters) unless otherwise noted

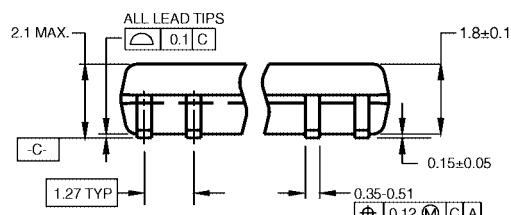


16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow  
Package Number M16A

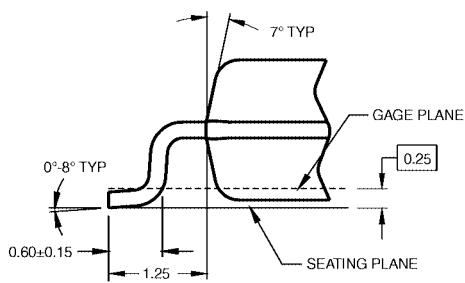
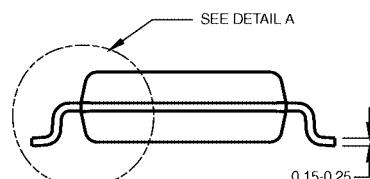
**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



LAND PATTERN RECOMMENDATION



DIMENSIONS ARE IN MILLIMETERS



DETAIL A

NOTES:

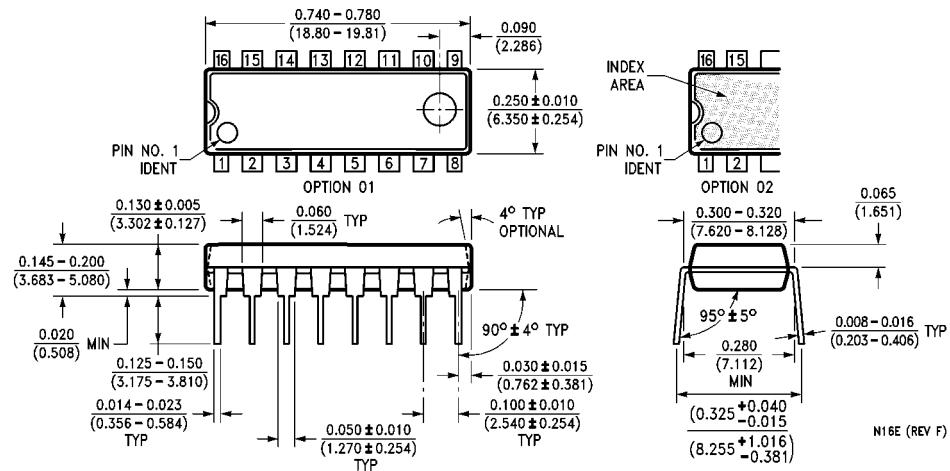
- A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M16DRevB1

16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide  
Package Number M16D

**MM74HC597 8-Bit Shift Registers with Input Latches**

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide  
Package Number N16E

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